

LC²MOS Precision Quad SPST Switches

ADG431/ADG432/ADG433

FEATURES

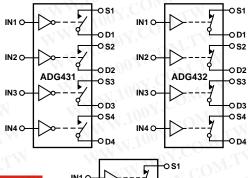
44 V Supply Maximum Ratings
±15 V Analog Signal Range
Low On Resistance (<24 Ω)
Ultralow Power Dissipation (3.9 μW)
Low Leakage (<0.25 nA)
Fast Switching Times
t_{ON} <165 ns
t_{OFF} <130 ns
Break-Before-Make Switching Action
TTL/CMOS Compatible
Plug-in Replacement for DG411/DG412/DG413

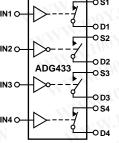
APPLICATIONS

Audio and Video Switching Automatic Test Equipment Precision Data Acquisition Battery Powered Systems Sample Hold Systems Communication Systems



FUNCTIONAL BLOCK DIAGRAMS





SWITCHES SHOWN FOR A LOGIC "1" INPUT

GENERAL DESCRIPTION

The ADG431, ADG432 and ADG433 are monolithic CMOS devices comprising four independently selectable switches. They are designed on an enhanced LC²MOS process which provides low power dissipation yet gives high switching speed and low on resistance.

The on resistance profile is very flat over the full analog input range ensuring excellent linearity and low distortion when switching audio signals. Fast switching speed coupled with high signal bandwidth also make the parts suitable for video signal switching. CMOS construction ensures ultralow power dissipation making the parts ideally suited for portable and battery powered instruments.

The ADG431, ADG432 and ADG433 contain four independent SPST switches. The ADG431 and ADG432 differ only in that the digital control logic is inverted. The ADG431 switches are turned on with a logic low on the appropriate control input, while a logic high is required for the ADG432. The ADG433 has two switches with digital control logic similar to that of the ADG431 while the logic is inverted on the other two switches.

Each switch conducts equally well in both directions when ON and has an input signal range which extends to the supplies. In the OFF condition, signal levels up to the supplies are blocked. All switches exhibit break before make switching action for use in multiplexer applications. Inherent in the design is low charge injection for minimum transients when switching the digital inputs.

PRODUCT HIGHLIGHTS

- 1. Extended Signal Range
 - The ADG431, ADG432 and ADG433 are fabricated on an enhanced LC²MOS process giving an increased signal range which extends fully to the supply rails.
- 2. Ultralow Power Dissipation
- 3. Low R_{ON}
- 4. Break-Before-Make Switching
 This prevents channel shorting when the switches are configured as a multiplexer.
- 5. Single Supply Operation
 For applications where the analog signal is unipolar, the ADG431, ADG432 and ADG433 can be operated from a single rail power supply. The parts are fully specified with a single +12 V power supply and will remain functional with single supplies as low as +5 V.

REV. B

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ADG431/ADG432/ADG433—SPECIFICATIONS¹

Dual Supply ($V_{DD}=+15~V~\pm~10\%,~V_{SS}=-15~V~\pm~10\%,~V_L=+5~V~\pm~10\%,~GND=0~V,~unless~otherwise~noted$)

Parameter	B '+25°C	Versions -40°C to +85°C	T V +25°C	versions -55°C to +125°C	Units	Test Conditions/Comments
ANALOG SWITCH Analog Signal Range R_{ON} R_{ON} vs. V_{D} (V_{S}) R_{ON} Drift R_{ON} Match	17 24 15 0.5 5	V _{DD} to V _{SS}	17 24 15 0.5 5	$ m V_{DD}$ to $ m V_{SS}$	V Ω typ Ω max % typ %/°C typ % typ	$V_D = \pm 8.5 \text{ V}, I_S = -10 \text{ mA};$ $V_{DD} = +13.5 \text{ V}, V_{SS} = -13.5 \text{ V}$ $V_D = 0 \text{ V}, I_S = -10 \text{ mA}$
LEAKAGE CURRENTS Source OFF Leakage I_S (OFF) Drain OFF Leakage I_D (OFF) Channel ON Leakage I_D , I_S (ON)	±0.05 ±0.25 ±0.05 ±0.25 ±0.1 ±0.35	±2 ±2 ±3	±0.05 ±0.25 ±0.05 ±0.25 ±0.1 ±0.35	±15 ±15 ±17	nA typ nA max nA typ nA max nA typ nA max	V_{DD} = +16.5 V, V_{SS} = -16.5 V V_{D} = ±15.5 V, V_{S} = ∓15.5 V; Test Circuit 2 V_{D} = ±15.5 V, V_{S} = ∓15.5 V; Test Circuit 2 V_{D} = V_{S} = ±15.5 V; Test Circuit 3
DIGITAL INPUTS Input High Voltage, V _{INH} Input Low Voltage, V _{INL} Input Current I _{INL} or I _{INH} C _{IN} Digital Input Capacitance	0.005	2.4 0.8 ±0.02	0.005	2.4 0.8 ±0.02	V min V max µA typ µA max pF typ	$V_{IN} = V_{INL}$ or V_{INH}
DYNAMIC CHARACTERISTICS ² t _{ON} t _{OFF} Break-Before-Make Time Delay, t _D (ADG433 Only) Charge Injection OFF Isolation Channel-to-Channel Crosstalk C _S (OFF) C _D (OFF) C _D , C _S (ON)	90 60 25 5 68 85 9 9 35	165 130	90 60 25 5 68 85 9 9 35	175 145	ns typ ns max ns typ ns max ns typ db typ db typ db typ pF typ pF typ pF typ	$\begin{split} &V_{\rm DD} = +15 \ V, V_{\rm SS} = -15 \ V \\ &R_{\rm L} = 300 \ \Omega, C_{\rm L} = 35 \ pF; \\ &V_{\rm S} = \pm 10 \ V; {\rm Test} \ {\rm Circuit} \ 4 \\ &R_{\rm L} = 300 \ \Omega, C_{\rm L} = 35 \ pF; \\ &V_{\rm S} = \pm 10 \ V; {\rm Test} \ {\rm Circuit} \ 4 \\ &R_{\rm L} = 300 \ \Omega, C_{\rm L} = 35 \ pF; \\ &V_{\rm S1} = V_{\rm S2} = +10 \ V; \\ &T_{\rm CS} = 10 \ V; V_{\rm S1} = V_{\rm S2} = +10 \ V; \\ &T_{\rm CS} = 10 \ V, R_{\rm S} = 0 \ \Omega, C_{\rm L} = 10 \ nF; \\ &T_{\rm CS} = 0 \ V, R_{\rm S} = 0 \ \Omega, C_{\rm L} = 10 \ nF; \\ &T_{\rm CS} = 0 \ V, C_{\rm L} = 5 \ pF, f = 1 \ MHz; \\ &T_{\rm CS} = 10 \ \Omega, C_{\rm L} = 5 \ pF, f = 1 \ MHz; \\ &T_{\rm CS} = 10 \ MHz \\ &T_{\rm SS} = 10$
POWER REQUIREMENTS I_{DD} I_{SS} I_{L} Power Dissipation	0.0001 0.1 0.0001 0.1 0.0001 0.1	0.2 0.2 0.2 7.7	0.0001 0.1 0.0001 0.1 0.0001 0.1	0.2 0.2 0.2 7.7	μΑ typ μΑ max μΑ typ μΑ max μΑ typ μΑ max μW max	V_{DD} = +16.5 V, V_{SS} = -16.5 V Digital Inputs = 0 V or 5 V

NOTES

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-2- REV. B

 $^{^1}$ Temperature ranges are as follows: B Versions: $-40\,^{\circ}$ C to $+85\,^{\circ}$ C; T Versions: $-55\,^{\circ}$ C to $+125\,^{\circ}$ C.

²Guaranteed by design, not subject to production test.

Specifications subject to change without notice.

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ADG431/ADG432/ADG433

Single Supply $(V_{DD} = +12 \text{ V} \pm 10\%, V_{SS} = 0 \text{ V}, V_L = +5 \text{ V} \pm 10\%, \text{ GND} = 0 \text{ V}, \text{ unless otherwise noted})$

100Y.COM.TW WW	W.10	Versions -40°C to +85°C		ersions -55°C to	1.100Y.	OM.TW
Parameter	+25°C	+85°C	+25°C	+125°C	Units	Test Conditions/Comments
ANALOG SWITCH Analog Signal Range R _{ON} R _{ON} vs. V _D (V _S) R _{ON} Drift R _{ON} Match	28 42 20 0.5 5	0 V to V _{DD} 45	28 42 20 0.5 5	0 V to V _{DD} 45	V Ω typ Ω max % typ %/°C typ % typ	$0 < V_D < 8.5 \text{ V}, I_S = -10 \text{ mA};$ $V_{DD} = +10.8 \text{ V}$ $V_D = 0 \text{ V}, I_S = -10 \text{ mA}$
LEAKAGE CURRENTS Source OFF Leakage I_S (OFF) Drain OFF Leakage I_D (OFF) Channel ON Leakage I_D , Is (ON)	±0.04 ±0.25 ±0.04 ±0.25 ±0.01 ±0.3	±2 ±2 ±3	±0.04 ±0.25 ±0.04 ±0.25 ±0.01 ±0.3	±15 ±15 ±17	nA typ nA max nA typ nA max nA typ nA max	$\begin{split} V_{DD} &= +13.2 \text{ V} \\ V_D &= 12.2/1 \text{ V}, \text{ V}_S = 1/12.2 \text{ V}; \\ \text{Test Circuit 2} \\ V_D &= 12.2/1 \text{ V}, \text{ V}_S = 1/12.2 \text{ V}; \\ \text{Test Circuit 2} \\ V_D &= V_S = +12.2 \text{ V}/+1 \text{ V}; \\ \text{Test Circuit 3} \end{split}$
DIGITAL INPUTS Input High Voltage, V_{INH} Input Low Voltage, V_{INL}	N	2.4 0.8	100X.	2.4 0.8	V min V max	WWW.100Y.COM.TW
Input Current I _{INL} or I _{INH}	0.005	±0.01	0.005	±0.01	μΑ typ μΑ max	$V_{IN} = V_{INL}$ or V_{INH}
C _{IN} Digital Input Capacitance	9	N 1	9	COM	pF typ	COM.
DYNAMIC CHARACTERISTICS ² t _{ON} t _{OFF} Break-Before-Make Time Delay, t _D (ADG433 Only) Charge Injection OFF Isolation	165 60 25 25 68	240 115	165 60 25 25 68	240 115	ns typ ns max ns typ ns max ns typ pC typ dB typ	$\begin{split} &V_{DD} = +12 \text{ V}, V_{SS} = 0 \text{ V} \\ &R_L = 300 \ \Omega, \ C_L = 35 \text{ pF}; \\ &V_S = +8 \text{ V}; \ \text{Test Circuit 4} \\ &R_L = 300 \ \Omega, \ C_L = 35 \text{ pF}; \\ &V_S = +8 \text{ V}; \ \text{Test Circuit 4} \\ &R_L = 300 \ \Omega, \ C_L = 35 \text{ pF}; \\ &V_{S1} = V_{S2} = +10 \text{ V}; \\ &Test \ \text{Circuit 5} \\ &V_S = 0 \text{ V}, \ R_S = 0 \ \Omega, \ C_L = 10 \text{ nF}; \\ &Test \ \text{Circuit 6} \\ &R_L = 50 \ \Omega, \ C_L = 5 \text{ pF}, \ f = 1 \text{ MHz}; \end{split}$
Channel-to-Channel Crosstalk	85		85		dB typ	Test Circuit 7 $R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; Test Circuit 8
C _S (OFF) C _D (OFF) C _D , C _S (ON)	9 9 35	CON.TV	9 9 35	MMM.	pF typ pF typ pF typ	f = 1 MHz f = 1 MHz f = 1 MHz
POWER REQUIREMENTS I_{DD} I_{L}	0.0001 0.03 0.0001 0.03	0.1	0.0001 0.03 0.0001 0.03	0.1	μΑ typ μΑ max μΑ typ μΑ max	V_{DD} = +13.2 V Digital Inputs = 0 V or 5 V V_{L} = +5.25 V
Power Dissipation	0.03	1.9	0.03	1.9	μΑ max	ν _L - 13.23 ν

NOTES

Truth Table (ADG431/ADG432)

ADG431 In	ADG432 In	Switch Condition
0	1	ON
1	0	OFF

Truth Table (ADG433)

Logic	Switch 1, 4	Switch 2, 3	
0	OFF	ON	
1	ON	OFF	

REV. B –3–

¹Temperature ranges are as follows: B Versions: −40 °C to +85 °C; T Versions: −55 °C to +125 °C.

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AUG431/AUG4	32/AUG433
ADSOLUTE MAYIM	HIM DATINGS

ABSOLUTE MAXIMUM RATIN	(GS)
$(T_A = +25^{\circ}C \text{ unless otherwise noted})$	
V_{DD} to V_{SS}	
V _{DD} to GND	0.3 V to +25 V
V _{SS} to GND	+0.3 V to -25 V
V_L to GND	
Analog, Digital Inputs ²	V_{SS} – 2 V to V_{DD} + 2 V or
	0 mA, Whichever Occurs First
Continuous Current, S or D	30 mA
Peak Current, S or D	
(Pulsed at 1 ms, 10% Duty Cycle	max)
Operating Temperature Range	
Industrial (B Version)	40°C to +85°C
Extended (T Version)	55°C to +125°C
Storage Temperature Range	65°C to +150°C
Junction Temperature	+150°C
Cerdip Package, Power Dissipation	

θ_{IA} , Thermal Impedance
Lead Temperature, Soldering (10 sec) +300°C
Plastic Package, Power Dissipation
θ _{JA} , Thermal Impedance
Lead Temperature, Soldering (10 sec) +260°C
SOIC Package, Power Dissipation 600 mW
θ_{JA} , Thermal Impedance
Lead Temperature, Soldering
Vapor Phase (60 sec)+215°C
Infrared (15 sec) +220°C

NOTES

¹Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Only one absolute maximum rating may be applied at any one time.

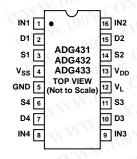
²Overvoltages at IN, S or D will be clamped by internal diodes. Current should be limited to the maximum ratings given.

CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the ADG431/ADG432/ADG433 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



PIN CONFIGURATION (DIP/SOIC)



ORDERING GUIDE

Model ¹	Temperature Range	Package Options ²
ADG431BN	-40°C to +85°C	N-16
ADG431BR	−40°C to +85°C	R-16A
ADG431TQ	−55°C to +125°C	Q-16
ADG431ABR	−40°C to +85°C	R-16A ³
ADG432BN	−40°C to +85°C	N-16
ADG432BR	−40°C to +85°C	R-16A
ADG432TQ	−55°C to +125°C	Q-16
ADG432ABR	−40°C to +85°C	$R-16A^3$
ADG433BN	−40°C to +85°C	N-16
ADG433BR	−40°C to +85°C	R-16A
ADG433ABR	-40°C to +85°C	R-16A ³

NOTES

¹To order MIL-STD-883, Class B processed parts, add /883B to T grade part numbers.

²N = Plastic DIP; R = 0.15" Small Outline IC (SOIC); Q = Cerdip.

TERMINOLOGY

V_{DD}	Most positive power supply potential.	C _S (OFF)	"OFF" switch source capacitance.
V_{SS}	Most negative power supply potential in dual	C _D (OFF)	"OFF" switch drain capacitance.
	supplies. In single supply applications, it may be	C_D , C_S (ON)	"ON" switch capacitance.
	connected to GND.	C_{IN}	Input Capacitance to ground of a digital input.
$V_{\rm L}$	Logic power supply (+5 V).	t _{ON}	Delay between applying the digital control input
GND	Ground (0 V) reference.		and the output switching on.
S	Source terminal. May be an input or output.	$t_{ m OFF}$	Delay between applying the digital control input
D	Drain terminal. May be an input or output.		and the output switching off.
IN	Logic control input.	t_{D}	"OFF" time or "ON" time measured between the
R_{ON}	Ohmic resistance between D and S.		90% points of both switches, when switching
R_{ON} vs. V_D (V_S)	The variation in R _{ON} due to a change in the ana-		from one address state to another.
	log input voltage with a constant load current.	Crosstalk	A measure of unwanted signal which is coupled
R _{ON} Drift	Change in R _{ON} vs. temperature.		through from one channel to another as a result
R _{ON} Match	Difference between the R _{ON} of any two switches.		of parasitic capacitance.
I _S (OFF)	Source leakage current with the switch "OFF."	Off Isolation	A measure of unwanted signal coupling through an
I_D (OFF)	Drain leakage current with the switch "OFF."		"OFF" switch.
$I_D, I_S (ON)$	Channel leakage current with the switch "ON."	Charge	A measure of the glitch impulse transferred from the
$V_{\rm D}(V_{\rm S})$	Analog voltage on terminals D, S.	Injection	digital input to the analog output during switching.

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³Trench isolated, latch-up proof parts. See Trench Isolation section.

Typical Performance Graphs

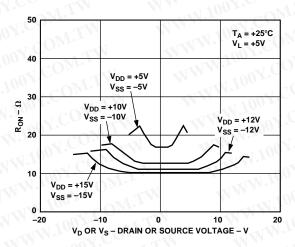


Figure 1. On Resistance as a Function of V_D (V_S) Dual Supplies

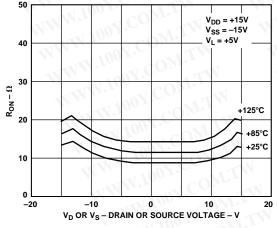


Figure 2. On Resistance as a Function of V_D (V_S) for Different Temperatures

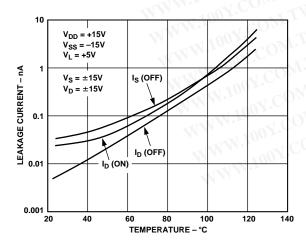


Figure 3. Leakage Currents as a Function of Temperature

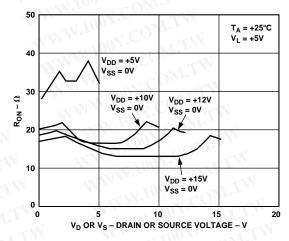


Figure 4. On Resistance as a Function of V_D (V_S) Single Supply

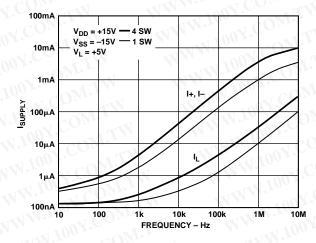


Figure 5. Supply Current vs. Input Switching Frequency

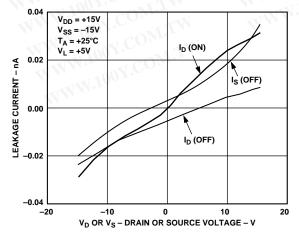


Figure 6. Leakage Currents as a Function of $V_D(V_S)$

REV. B –5–

ADG431/ADG432/ADG433

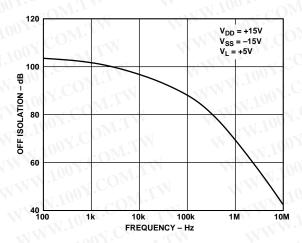


Figure 7. Off Isolation vs. Frequency

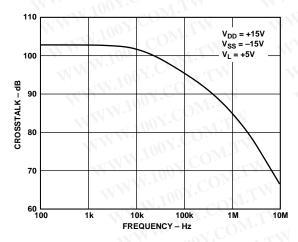


Figure 8. Crosstalk vs. Frequency

TRENCH ISOLATION

In the ADG431A, ADG432A and ADG433A, an insulating oxide layer (trench) is placed between the NMOS and PMOS transistors of each CMOS switch. Parasitic junctions, which occur between the transistors in junction isolated switches, are eliminated, the result being a completely latch-up proof switch.

In junction isolation, the N and P wells of the PMOS and NMOS transistors from a diode that is reverse-biased under normal operation. However, during overvoltage conditions, this diode becomes forward biased. A silicon-controlled rectifier (SCR) type circuit is formed by the two transistors causing a significant amplification of the current which, in turn, leads to latch up. With trench isolation, this diode is removed, the result being a latch-up proof switch.

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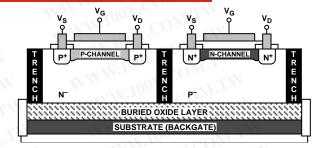


Figure 9. Trench Isolation

APPLICATION

Figure 10 illustrates a precise, fast sample-and-hold circuit. An AD845 is used as the input buffer while the output operational amplifier is an AD711. During the track mode, SW1 is closed and the output $V_{\rm OUT}$ follows the input signal $V_{\rm IN}$. In the hold mode, SW1 is opened and the signal is held by the hold capacitor $C_{\rm H}$.

Due to switch and capacitor leakage, the voltage on the hold capacitor will decrease with time. The ADG431/ADG432/ ADG433 minimizes this droop due to its low leakage specifications. The droop rate is further minimized by the use of a polystyrene hold capacitor. The droop rate for the circuit shown is typically 30 $\mu V/\mu s$.

A second switch SW2, which operates in parallel with SW1, is included in this circuit to reduce pedestal error. Since both switches will be at the same potential, they will have a differential effect on the op amp AD711 which will minimize charge injection effects. Pedestal error is also reduced by the compensation network $R_{\rm C}$ and $C_{\rm C}$. This compensation network also reduces the hold time glitch while optimizing the acquisition time. Using the illustrated op amps and component values, the pedestal error has a maximum value of 5 mV over the ± 10 V input range. Both the acquisition and settling times are 850 ns.

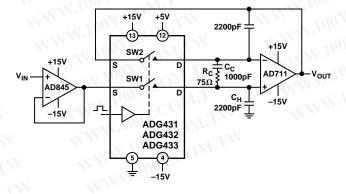


Figure 10. Fast, Accurate Sample-and-Hold

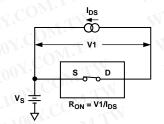
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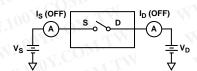
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Test Circuits

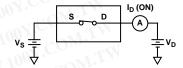
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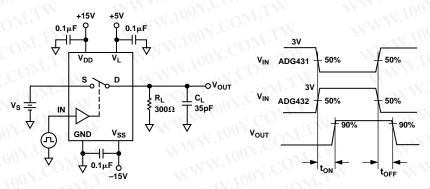
Test Circuit 1. On Resistance



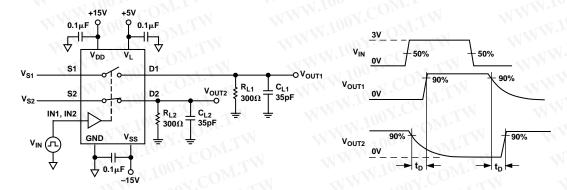
Test Circuit 2. Off Leakage



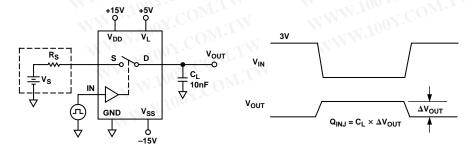
Test Circuit 3. On Leakage



Test Circuit 4. Switching Times

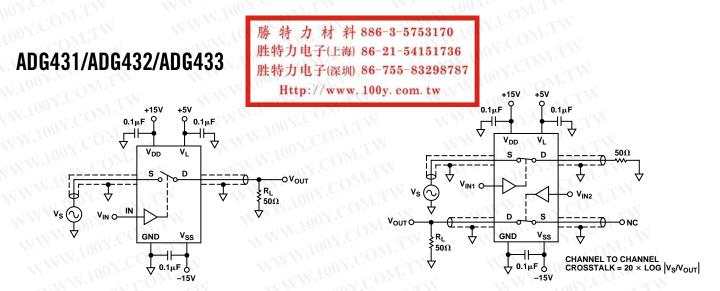


Test Circuit 5. Break-Before-Make Time Delay



Test Circuit 6. Charge Injection

REV. B -7-

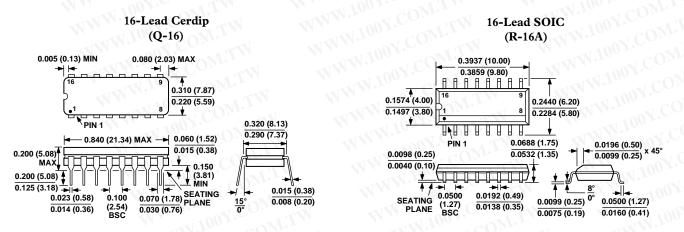


Test Circuit 7. Off Isolation

Test Circuit 8. Channel-to-Channel Crosstalk

OUTLINE DIMENSIONS

Dimensions shown in inches and (mm).



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16-Lead Plastic DIP (Narrow) (N-16)

